

(	)	<b>Preliminary Specifications</b>
(	<b>V</b>	Final Specifications

Module	12.1" WXGA Color TFT-LCD with LED Backlight design		
Model Name	B121EW10 V2 (HW: 0A)		
Note ( 🗭 )	LED Backlight with driving circuit design		

Customer	Date	Approved by	Date
		<u>Ivy Lee</u>	12/10/2008
Checked & Approved by	Date	Prepared by	
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Note: This Specification is sub notice.	ject to change without	NBBU Market AU Optronics	ing Division / s corporation



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# **Record of Revision**

Ver	Version and Date Page		Old description	New Description	Remark
0.1	2008/06/10	AII	First Edition for Customer		
0.2	2008/6/23	5	Module Thickness 3.5mm max.	Module Thickness modified to 3.65mm max.	
		5	Module weight 250g max	Module weight 260g max.	
		29,30, 31,32	Module 2D Drawing	(1) Modified CN location & Module thickness.	
	0000/10/0		5: 10	(2) PCBA component limited height	
1.0	2008/12/2		Final Spec		



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## 1. Handling Precautions

- 1) Since front polarizer is easily damaged, pay attention not to scratch it.
- 2) Be sure to turn off power supply when inserting or disconnecting from input connector.
- 3) Wipe off water drop immediately. Long contact with water may cause discoloration or spots.
- 4) When the panel surface is soiled, wipe it with absorbent cotton or other soft cloth.
- 5) Since the panel is made of glass, it may break or crack if dropped or bumped on hard surface.
- 6) Since CMOS LSI is used in this module, take care of static electricity and insure human earth when handling.
- 7) Do not open nor modify the Module Assembly.
- 8) Do not press the reflector sheet at the back of the module to any directions.
- 9) At the insertion or removal of the Signal Interface Connector, be sure not to rotate nor tilt the Interface Connector of the TFT Module.
- 11)After installation of the TFT Module into an enclosure (Notebook PC Bezel, for example), do not twist nor bend the TFT Module even momentary. At designing the enclosure, it should be taken into consideration that no bending/twisting forces are applied to the TFT Module from outside. Otherwise the TFT Module may be damaged.
- 12) Small amount of materials having no flammability grade is used in the LCD module. The LCD module should be supplied by power complied with requirements of Limited Power Source (IEC60950 or UL1950), or be applied exemption.
- 13) Disconnecting power supply before handling LCD modules, it can prevent electric shock, DO NOT TOUCH the electrode parts, cables, connectors and LED circuit part of TFT module that a LED light bar build in as a light source of back light unit. It can prevent electrostic breakdown.



## 2. General Description

B121EW10 V2 is a Color Active Matrix Liquid Crystal Display composed of a TFT LCD panel, a driver circuit, and LED backlight system. The screen format is intended to support the WXGA (1280(H) x 800(V)) screen and 262k colors (RGB 6-bits data driver) with LED backlight driving circuit. All input signals are LVDS interface compatible.

B121EW10 V2 is designed for a display unit of notebook style personal computer and industrial machine.

## 2.1 General Specification

The following items are characteristics summary on the table at 25  $^{\circ}\mathrm{C}$  condition:

Items	Unit		Specifi	ications		
Screen Diagonal	[mm]	12.1W"				
Active Area	[mm]	261.12 x 16	63.2			
Pixels H x V		1280x3(RGB) x 800				
Pixel Pitch	[mm]	0.204				
Pixel Format		B.G.R. Ver	tical Stripe			
Display Mode		Normally W	/hite			
White Luminance (ILED=20mA) (Note: ILED is LED current)	[cd/m <sup>2</sup> ]	220 typ. (5 points average) 187 min. (5 points average) (Note1)				
Luminance Uniformity		1.25 max. (5 points)				
Contrast Ratio		500 typ				
Response Time	[ms]	16 typ				
Nominal Input Voltage VDD	[Volt]	+3.3 typ.				
Power Consumption	[Watt]	4.5 max. (Ir	nclude Logic	and Blu po	wer) (Note1)	
Weight	[Grams]	260 max.				
Physical Size without inverter,	[mm]		Min.	Тур.	Max.	
bracket.		Length	283.42	283.92	284.42	
		Width	189	189.5	190	
		Thickness	-	_	3.65	
Electrical Interface		1 channel LVDS				
Glass Thickness	[mm]	0.5				
Surface Treatment		Glare, Hardness 3H, Reflection < 5%				
Support Color		262K colors	s ( RGB 6-bi	t )		



Temperature Range Operating Storage (Non-Operating)	[°C] [°C]	0 to +50 -20 to +65
RoHS Compliance		RoHS Compliance

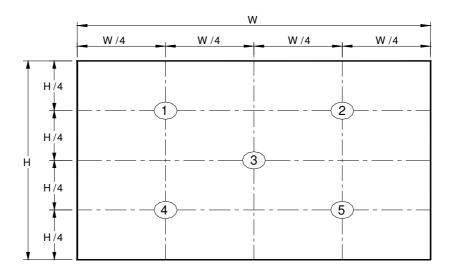
## 2.2 Optical Characteristics

The optical characteristics are measured under stable conditions at 25°C (Room Temperature):

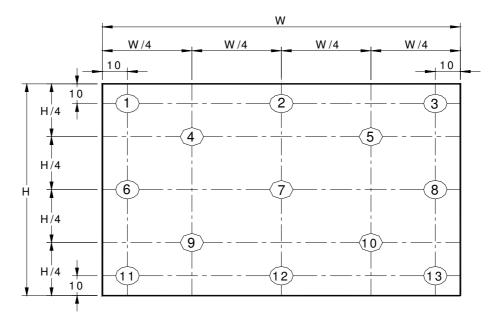
Item		Symbol	Conditions	Min.	Typ.	Max.	Unit	Note
White Luminance ILED=20mA			5 points average	187	220	-	cd/m	1, 4, 5.
Viewing Ar	aala	θR θL	Horizontal (Right) CR = 10 (Left)	40 40	45 45	-	degre e	
viewing Ai	igie	<b>ф</b> н <b>ф</b> ∟	Vertical (Upper) CR = 10 (Lower)	10 30	15 35	-		4, 9
Luminan Uniformi		δ <sub>5P</sub>	5 Points	-	-	1.25		1, 3, 4
Luminance Uniformity		δ <sub>13P</sub>	13 Points	-	-	1.50		2, 3, 4
Contrast Ratio		CR		400	500	-		4, 6
Cross talk		%				4		4, 7
			Rising	-	9	-		
Response 7	Гime	$T_f$	Falling	-	7	-	msec	4, 8
		T <sub>RT</sub>	Rising + Falling	-	16	25		
	Red	Rx		0.570	0.600	0.630		
	Green	Ry		0.310	0.340	0.370		
		Gx		0.290	0.320	0.350		
Color / Chromaticity	Green	Gy		0.520	0.550	0.580		
Coodinates	Dive	Bx	CIE 1931	0.120	0.150	0.180		4
	Blue	Ву		0.110	0.140	0.170		
	\ <b>\</b> /  <b>b</b> :+-	Wx		0.283	0.313	0.343		
	White	Wy		0.299	0.329	0.359		
NTSC		%		-	45	-		



Note 1: 5 points position (Ref: Active area)



Note 2: 13 points position (Ref: Active area)



Note 3: The luminance uniformity of 5 or 13 points is defined by dividing the maximum luminance values by the minimum test point luminance

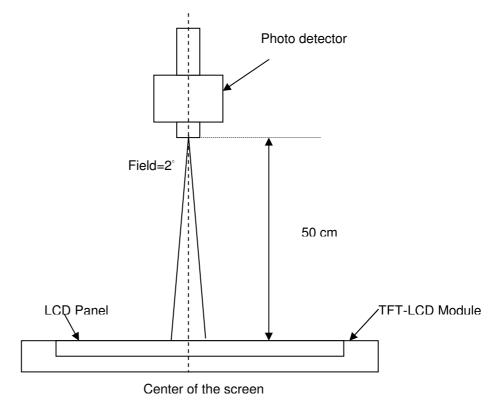
2		Maximum Brightness of five points
δ w5	=	Minimum Brightness of five points
2	_	Maximum Brightness of thirteen points
δ w13	= '	Minimum Brightness of thirteen points

### Note 4: Measurement method

The LCD module should be stabilized at given temperature for 30 minutes to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting



Backlight for 30 minutes in a stable, windless and dark room, and it should be measured in the center of screen.



**Note 5**: Definition of Average Luminance of White (Y<sub>L</sub>):

Measure the luminance of gray level 63 at 5 points  $\cdot$   $Y_L = [L(1) + L(2) + L(3) + L(4) + L(5)] / 5$ L (x) is corresponding to the luminance of the point X at Figure in Note (1).

**Note 6**: Definition of contrast ratio:

Contrast ratio is calculated with the following formula.

Brightness on the "White" state Contrast ratio (CR)= Brightness on the "Black" state

Note 7: Definition of Cross Talk (CT)

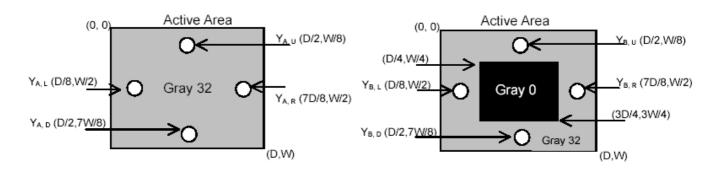
$$CT = |Y_B - Y_A| / Y_A \times 100 (\%)$$

Where

Y<sub>A</sub> = Luminance of measured location without gray level 0 pattern (cd/m<sub>2</sub>)

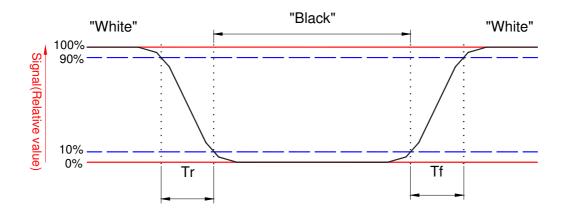
Y<sub>B</sub> = Luminance of measured location with gray level 0 pattern (cd/m<sub>2</sub>)





Note 8: Definition of response time:

The output signals of BM-7 or equivalent are measured when the input signals are changed from "Black" to "White" (falling time) and from "White" to "Black" (rising time), respectively. The response time interval between the 10% and 90% of amplitudes. Refer to figure as below.





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### Note 9. Definition of viewing angle

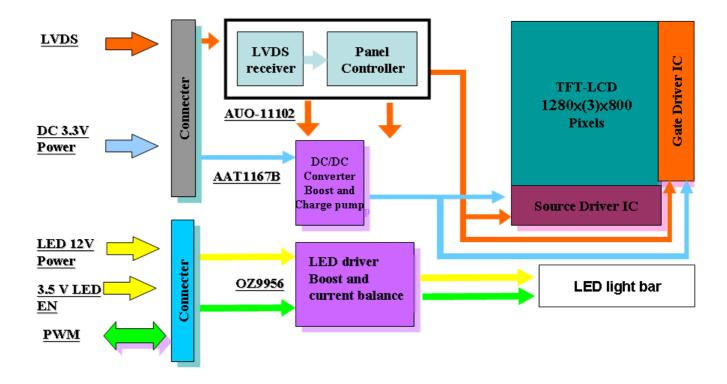
Viewing angle is the measurement of contrast ratio  $\geq$  10, at the screen center, over a 180° horizontal and 180° vertical range (off-normal viewing angles). The 180° viewing angle range is broken down as follows; 90° ( $\theta$ ) horizontal left and right and 90° ( $\Phi$ ) vertical, high (up) and low (down). The measurement direction is typically perpendicular to the display surface with the screen rotated about its center to develop the desired measurement viewing angle.





## 3. Functional Block Diagram

The following diagram shows the functional block of the 12.1 inches wide Color TFT/LCD 40 Pin (One CH/connector Module)





## 4. Absolute Maximum Ratings

An absolute maximum rating of the module is as following:

## 4.1 Absolute Ratings of TFT LCD Module

Item	Symbol	Min	Max	Unit	Conditions
Logic/LCD Drive Voltage	Vin	-0.3	+4.0	[Volt]	Note 1,2

4.2 Absolute Ratings of Environment

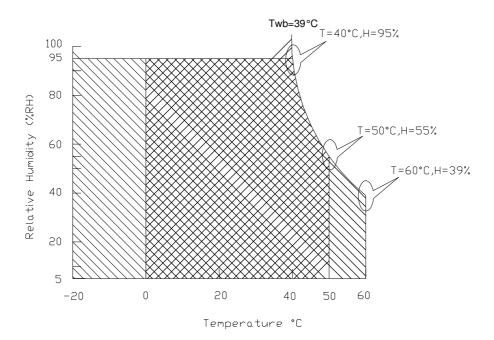
Item	Symbol	Min	Max	Unit	Conditions			
Operating Temperature	TOP	0	+50	[°C]	Note 4			
Operation Humidity	HOP	8	95	[%RH]	Note 4			
Storage Temperature	TST	-20	+65	[°C]	Note 4			
Storage Humidity	HST	5	95	[%RH]	Note 4			

Note 1: At Ta (25°C)

Note 2: Permanent damage to the device may occur if exceed maximum values

Note 3: LED specification refer to section 5.2

Note 4: For quality performance, please refer to AUO IIS (Incoming Inspection Standard).



Operating Range

Storage Range

+

## 5. Electrical characteristics

### **5.1 TFT LCD Module**

### 5.1.1 Power Specification

Input power specifications are as follows;

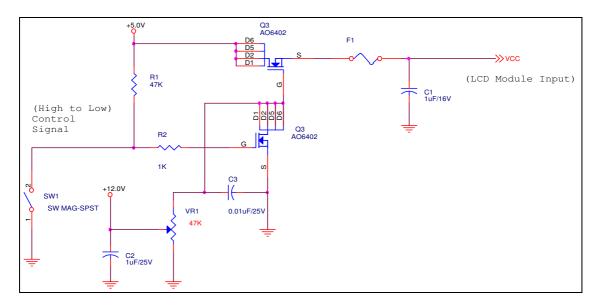
The power specification are measured under 25°C and frame frenquency under 60Hz

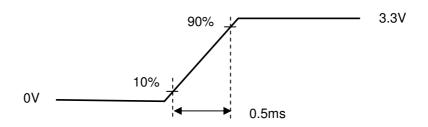
Symble	Parameter	Min	Тур	Max	Units	Note
VDD	Logic/LCD Drive Voltage	3.0	3.3	3.6	[Volt]	
PDD	VDD Power	0.5	0.53	0.55	[Watt]	Note 1/2
IDD	IDD Current	153	161	166.6	[mA]	Note 1/2
lRush	Inrush Current	-	-	540	[mA]	Note 3
VDDrp	Allowable Logic/LCD Drive Ripple Voltage	-	-	200	[mV] p-p	

Note 1: Maximum Measurement Condition: Black Pattern

Note 2: Typical Measurement Condition: Mosaic Pattern

### Note 3: Measure Condition







### **5.1.2 Signal Electrical Characteristics**

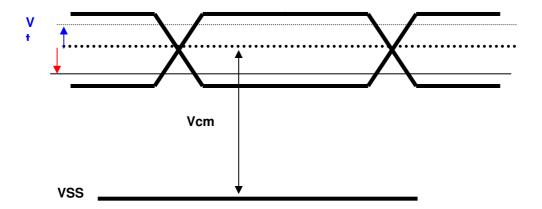
Input signals shall be low or High-impedance state when VDD is off.

It is recommended to refer the specifications of THC63LVDF84A (Thine Electronics Inc.) in detail.

Signal electrical characteristics are as follows;

Parameter	Condition	Min	Max	Unit
Vth	Differential Input High Threshold (Vcm=+1.2V)	-	100	[mV]
Vtl	Differential Input Low Threshold (Vcm=+1.2V)	-100	-	[mV]
Vcm	Differential Input Common Mode Voltage	1.125	1.375	[V]

Note: LVDS Signal Waveform





### LED Parameter guideline for LED driving selection (Ref. Remark 1)

Parameter	Symbol	Min	Тур	Max	Units	Condition
LED Forward Voltage	V <sub>F</sub>	3.0	3.2	3.4	[Volt]	(Ta=25°ℂ)
LED Forward Current	I <sub>F</sub>			20	[mA]	(Ta=25°C)
LED Power consumption	P <sub>LED</sub>			2.856	[Watt]	(Ta=25°ℂ) Note 1
LED Life-Time	N/A	10,000	-	-	Hour	(Ta=25°C) I <sub>F</sub> =20 mA Note 2
Output PWM frequency	F <sub>PWM</sub>	100	200	20K	Hz	
Duty ratio		4.3		96	%	

Note 1: Calculator value for reference IF×VF =P

Note 2: The LED life-time define as the estimated time to 50% degradation of initial luminous.



## 6. Signal Characteristic

## 6.1 Pixel Format Image

Following figure shows the relationship of the input signals and LCD pixel format.

	1						12	80	)
1st Line	R G B	R G B		R	G	В	R	G	В
	1	1	-					`	
	1							`	
								`	
	,								
			· .						
		,						•	
	'	'	'		<u>'</u>			`	
800th Line	R G B	R G B		R	G	В	R	G	В



## 6.2 The input data format

RxCLKIN		/
RxIN0	G0 R5 R4 R3 R2	R1 R0
RxIN1	B1 B0 G5 G4 G3	G2 G1
RxIN2	DE VS HS B5 B4	B3 B2

Cianal Nama	Description	
Signal Name	Description (MCD)	Dad sixel Data
R5	Red Data 5 (MSB)	Red-pixel Data
R4	Red Data 4	Each red pixel's brightness data consists of
R3	Red Data 3	these 6 bits pixel data.
R2	Red Data 2	
R1	Red Data 1	
R0	Red Data 0 (LSB)	
	Red-pixel Data	
	·	
G5	Green Data 5 (MSB)	Green-pixel Data
G4	Green Data 4	Each green pixel's brightness data consists of
G3	Green Data 3	these 6 bits pixel data.
G2	Green Data 2	
G1	Green Data 1	
G0	Green Data 0 (LSB)	
	Green-pixel Data	
B5	Blue Data 5 (MSB)	Blue-pixel Data
B4	Blue Data 4	Each blue pixel's brightness data consists of
B3	Blue Data 3	these 6 bits pixel data.
B2	Blue Data 2	
B1	Blue Data 1	
B0	Blue Data 0 (LSB)	
	, ,	
	Blue-pixel Data	
RxCLKIN	Data Clock	The signal is used to strobe the pixel data and
		DE signals. All pixel data shall be valid at the
		falling edge when the DE signal is high.
DE	Display Timing	This signal is strobed at the falling edge of
		RxCLKIN. When the signal is high, the pixel
		data shall be valid to be displayed.
VS	Vertical Sync	The signal is synchronized to RxCLKIN.
HS	Horizontal Sync	The signal is synchronized to RxCLKIN.

Note: Output signals from any system shall be low or High-impedance state when VDD is off.



## 6.3 Integration Interface and Pin Assignment

LVDS is a differential signal technology for LCD interface and high speed data transfer device.

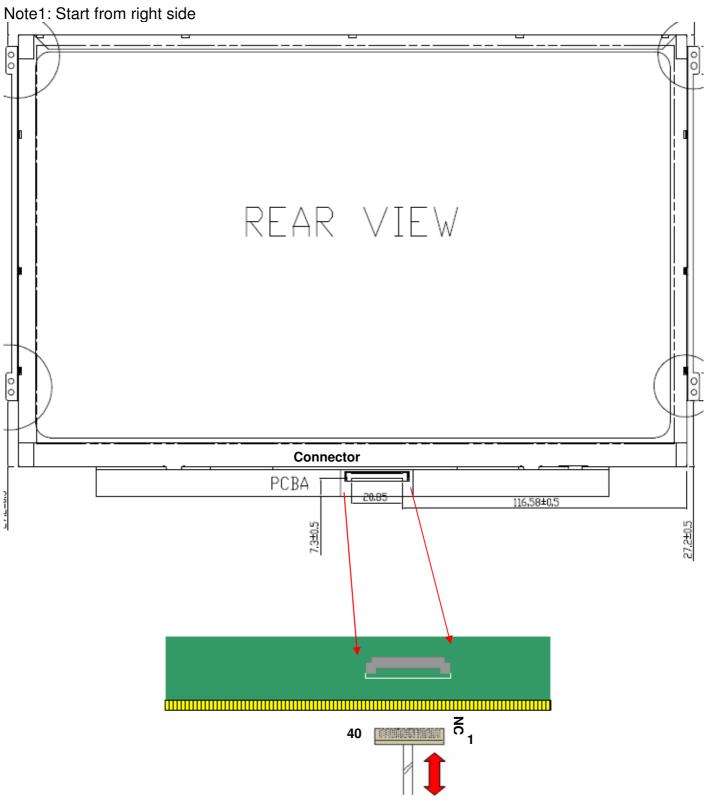
	B121EW10 V2					
Pin	Signal	Description				
1	NC	No Connection (Reserve)				
2	VDD	PowerSupply,3.3V(typical)				
3	VDD	PowerSupply,3.3V(typical)				
4	DVDD	DDC 3.3Vpower				
5	NC	No Connection (Reserve)				
6	SCL	DDCClock				
7	SDA	DDCData				
8	Rin0-	-LVDSdifferential data input(R0-R5,G0)				
9	Rin0+	+LVDSdifferential data input(R0-R5,G0)				
10	GND	Ground				
11	Rin1-	-LVDSdifferential data input(G1-G5,B0-B1)				
12	Rin1+	+LVDSdifferential data input(G1-G5,B0-B1)				
13	GND	Ground				
14	Rin2-	-LVDSdifferential data input(B2-B5,HS,VS,DE)				
15	Rin2+	+LVDSdifferential data input(B2-B5,HS,VS,DE)				
16	GND	Ground				
17	ClkIN-	-LVDSdifferential clock input				
18	ClkIN+	+LVDSdifferential clock input				
19	GND	Ground				
20	NC	No Connection (Reserve)				
21	NC	No Connection (Reserve)				
22	GND	Ground				
23	NC	No Connection (Reserve)				
24	NC	No Connection (Reserve)				
25	GND	Ground-Shield				
26	NC	No Connection (Reserve)				
27	NC	No Connection (Reserve)				
28	GND	Ground-Shield				
29	NC	No Connection (Reserve)				
30	NC	No Connection (Reserve)				
31	VLED_GND	LED Ground				
32	VLED_GND	LED Ground				
33	VLED_GND	LED Ground				
34	NC	No Connection (Reserve)				
35	PWM	System PWM Signal Input				
36	LED_EN	LED enable pin(+3V Input)				



37	NC	No Connection (Reserve)
38	VLED	LED Power Supply 7V-20V
39	VLED	LED Power Supply 7V-20V
40	VLED	LED Power Supply 7V-20V



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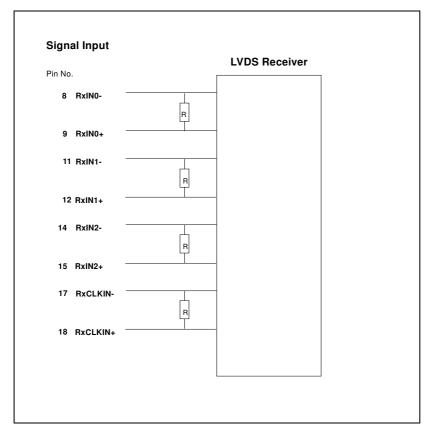
Note2: Input signals shall be low or High-impedance state when VDD is off.



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internal circuit of LVDS inputs are as following.

The module uses a 100ohm resistor between positive and negative data lines of each receiver input





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### 6.4 Interface Timing

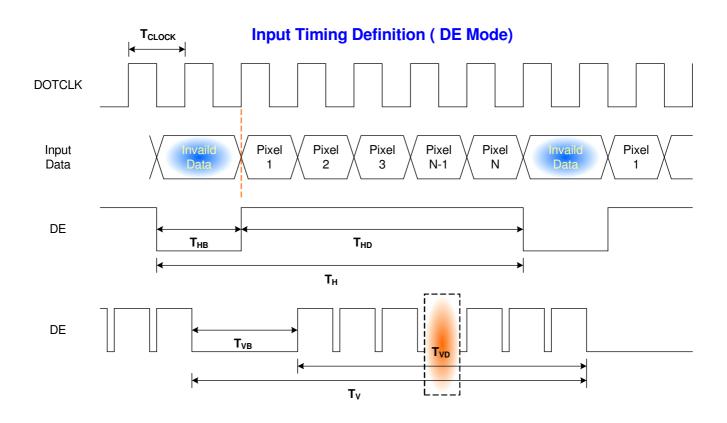
### 6.4.1 Timing Characteristics

Basically, interface timings should match the 1280x800 /60Hz manufacturing guide line timing.

Parai	neter	Symbol	Min.	Тур.	Max.	Unit
Frame	e Rate	-		60		Hz
Clock from	equency	1/ T <sub>Clock</sub>		68.9		MHz
	Period	T <sub>V</sub>	803	823	•	
Vertical	Active	T <sub>VD</sub>		800		$T_{Line}$
Section	Blanking	<b>T</b> <sub>VB</sub>		16	•	
	Period	T <sub>H</sub>	1303	1440	•	
Horizontal	Active	<b>T</b> <sub>HD</sub>		1280		T <sub>Clock</sub>
Section	Blanking	<b>T</b> <sub>HB</sub>		126	-	

Note: DE mode only

### 6.4.2 Timing diagram

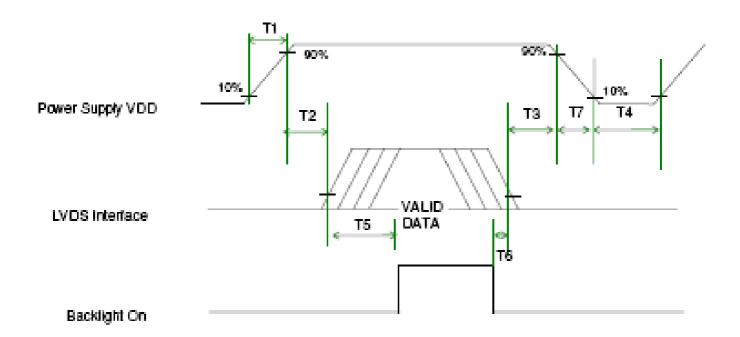




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### 6.5 Power ON/OFF Sequence

VDD power on/off sequence is as follows. Interface signals are also shown in the chart. Signals from any system shall be Hi-Z state or low level when VDD is off

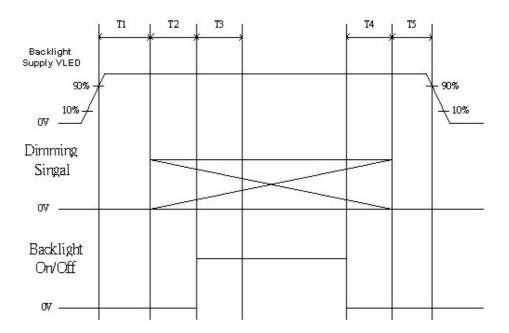


### **Power Sequence Timing**

		Value		
Parameter	Min.	Тур.	Max.	Units
T1	0.5	_	10	
T2	0	-	50	
Т3	0	-	50	
T4	400	-	-	ms
Т5	200	-	-	
Т6	200	-	-	
Т7	0	-	10	



LED on/off sequence is as follows. Interface signals are also shown in the chart.



		Values				
Symbol	Min	Тур	Max	Unit		
T1	10					
T2	10					
Т3	50			ms		
T4	0					
Т5	10					



# 7. Connector Description

Physical interface is described as for the connector on module.

These connectors are capable of accommodating the following signals and will be following components.

### 7.1 TFT LCD Module

Connector Name / Designation	For Signal Connector
Manufacturer	IPEX or compatible
Type / Part Number	IPEX 20455-040E-12A
Mating Housing/Part Number	IPEX 20453-040T-11



## 8. LED Driving Specification

## **8.1 Connector Description**

It is a intergrative interface and comibe into LVDS connector. The type and mating refer to section 7.

## 8.2 Pin Assignment

Ref. to 6.3



### 9. Vibration and Shock Test

### 9.1 Vibration Test

**Test Spec:** 

Test method: Non-Operation

Acceleration: 1.5 G

Frequency: 10 - 500Hz Random

Sweep: 30 Minutes each Axis (X, Y, Z)

## 9.2 Shock Test Spec:

**Test Spec:** 

Test method: Non-Operation

Acceleration: 220 G, Half sine wave

Active time: 2 ms

Pulse: X,Y,Z .one time for each side



## 10. Reliability

Items	Required Condition	Note
Temperature Humidity Bias	Ta= 40℃, 90%RH, 300h	
High Temperature Operation	Ta= 50℃, Dry, 300h	
Low Temperature Operation	Ta= 0℃, 300h	
High Temperature Storage	Ta= 60℃, 35%RH, 300h	
Low Temperature Storage	Ta= -20℃, 50%RH, 250h	
Thermal Shock Test	Ta=-20℃to 60℃, Duration at 30 min, 100 cycles	
ESD	Contact : ±8 KV	Note 1
LSD	Air: ±15 KV	

Note1: According to EN 61000-4-2, ESD class B: Some performance degradation allowed. No data lost

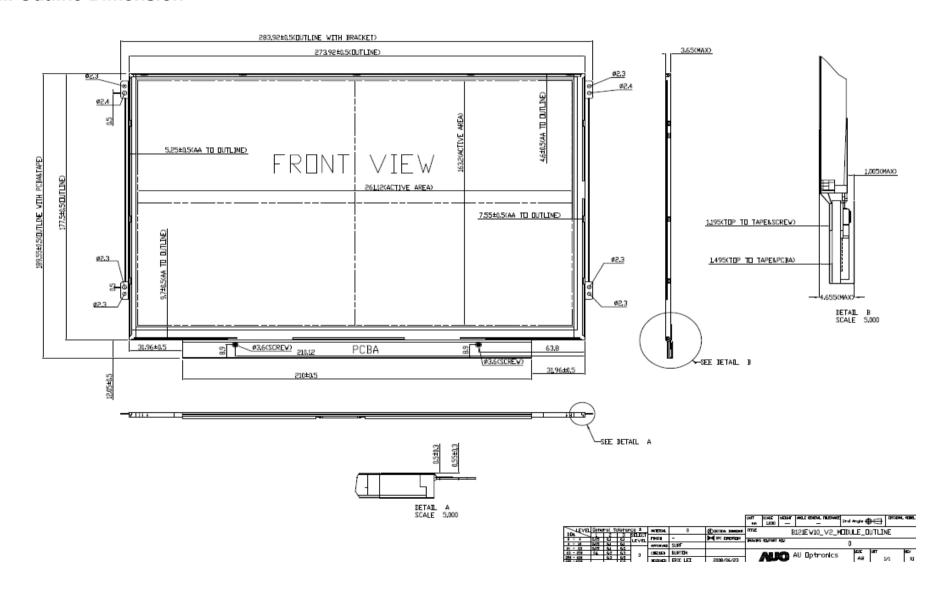
. Self-recoverable. No hardware failures.

Remark: MTBF (Excluding the LED): 30,000 hours with a confidence level 90%



### 11. Mechanical Characteristics

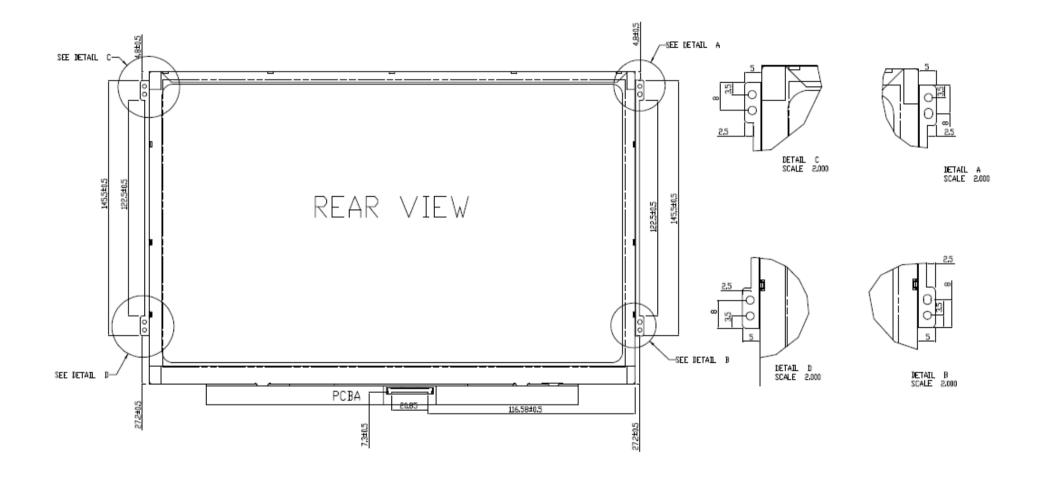
### 11.1 LCM Outline Dimension



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Note: Prevention IC damage, IC positions not allowed any overlap over these areas.

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## 12. Shipping and Package

## 12.1 Shipping Label Format



Manufactured xx/xx

Model No: B121EW10 V2

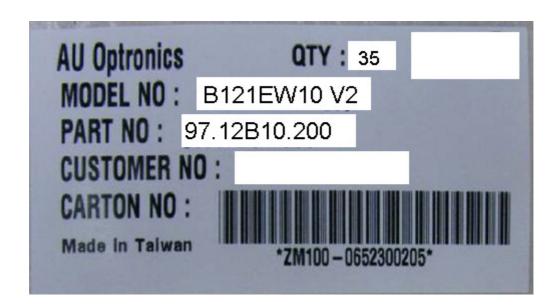
**AU Optronics OAXXG** 

MADE IN CHINA (S01)

H/W: 0A F/W:1



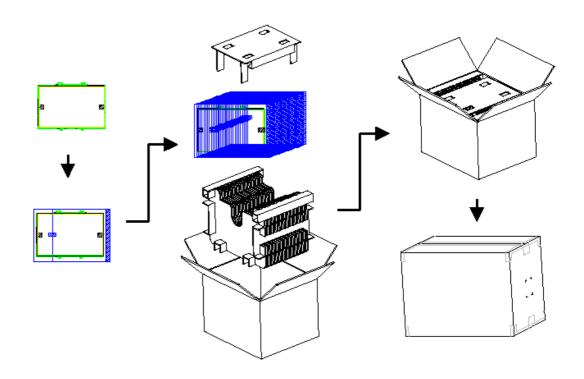




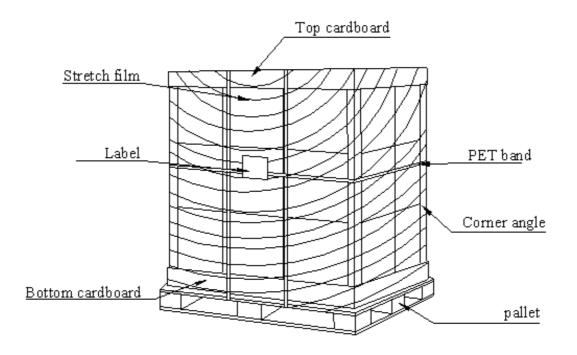


## 12.2 Carton package

The outside dimension of carton is 455 (L)mm x 380 (W)mm x 355 (H)mm



## 12.3 Shipping package of palletizing sequence





13. Appendix: EDID description

Address	FUNCTION	Value	Value	Value	Note
HEX		HEX	BIN	DEC	
00	Header	00	00000000	0	
01		FF	11111111	255	
02		FF	11111111	255	
03		FF	11111111	255	
04		FF	11111111	255	
05		FF	11111111	255	
06		FF	11111111	255	
07		00	00000000	0	
08	EISA Manuf. Code LSB	06	00000110	6	
09	Compressed ASCII	AF	10101111	175	
0A	Product Code	14	00010100	20	
0B	hex, LSB first	A2	10100010	162	
0C	32-bit ser #	00	00000000	0	
0D		00	00000000	0	
0E		00	00000000	0	
0F		00	00000000	0	
10	Week of manufacture	01	00000001	1	
11	Year of manufacture	12	00010010	18	
12	EDID Structure Ver.	01	00000001	1	
13	EDID revision #	03	00000011	3	
14	Video input def. (digital I/P, non-TMDS, CRGB)	80	10000000	128	
15	Max H image size (rounded to cm)	1A	00011010	26	
16	Max V image size (rounded to cm)	10	00010000	16	
17	Display Gamma (=(gamma*100)-100)	78	01111000	120	
18	Feature support (no DPMS, Active OFF, RGB, tmg Blk#1)	0A	00001010	10	
19	Red/green low bits (Lower 2:2:2:2 bits)	89	10001001	137	
1 <b>A</b>	Blue/white low bits (Lower 2:2:2:2 bits)	E5	11100101	229	
1B	Red x (Upper 8 bits)	94	10010100	148	
1C	Red y/ highER 8 bits	57	01010111	87	
1D	Green x	54	01010100	84	
1E	Green y	93	10010011	147	
1F	Blue x	27	00100111	39	
20	Blue y	22	00100010	34	
21	White x	50	01010000	80	
22	White y	54	01010100	84	
23	Established timing 1	00	00000000	0	
24	Established timing 2	00	00000000	0	
25	Established timing 3	00	00000000	0	
26	Standard timing #1	01	00000001	1	
27		01	0000001	1	
28	Standard timing #2	01	00000001	1	
29		01	0000001	1	
2A	Standard timing #3	01	00000001	1	
2B		01	00000001	1	



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2C	Standard timing #4	01	00000001	1	
2D		01	00000001	1	
2E	Standard timing #5	01	00000001	1	
2F		01	00000001	1	
30	Standard timing #6	01	00000001	1	
31		01	00000001	1	
32	Standard timing #7	01	00000001	1	
33		01	00000001	1	
34	Standard timing #8	01	00000001	1	
35		01	00000001	1	
36	Pixel Clock/10000 LSB	EA	11101010	234	
37	Pixel Clock/10000 USB	1A	00011010	26	
38	Horz active Lower 8bits	00	00000000	0	
39	Horz blanking Lower 8bits	7E	01111110	126	
3A	HorzAct:HorzBlnk Upper 4:4 bits	50	01010000	80	
3B	Vertical Active Lower 8bits	20	00100000	32	
3C	Vertical Blanking Lower 8bits	10	00010000	16	
3D	Vert Act : Vertical Blanking (upper 4:4 bit)	30	00110000	48	
3E	HorzSync. Offset	30	00110000	48	
3F	HorzSync.Width	20	00100000	32	
40	VertSync.Offset : VertSync.Width	36	00110110	54	
41	Horz‖ Sync Offset/Width Upper 2bits	00	00000000	0	
42	Horizontal Image Size Lower 8bits	05	00000101	5	
43	Vertical Image Size Lower 8bits	А3	10100011	163	
44	Horizontal & Vertical Image Size (upper 4:4 bits)	10	00010000	16	
45	Horizontal Border (zero for internal LCD)	00	00000000	0	
46	Vertical Border (zero for internal LCD)	00	00000000	0	
47	Signal (non-intr, norm, no stero, sep sync, neg pol)	18	00011000	24	
48	Detailed timing/monitor	00	00000000	0	
49	descriptor #2	00	00000000	0	
4A		00	00000000	0	
4B		0F	00001111	15	
4C		00	00000000	0	
4D		00	00000000	0	
4E		00	00000000	0	
4F		00	00000000	0	
50		00	00000000	0	
51		00	00000000	0	
52		00	00000000	0	
53		00	00000000	0	
54		00	00000000	0	
55		00	00000000	0	
56		00	00000000	0	
57		00	00000000	0	
58		00	00000000	0	
59		20	00100000	32	
5A	Detailed timing/monitor	00	00000000	0	



		1	1		
5B	descriptor #3	00	00000000	0	
5C		00	00000000	0	
5D		FE	11111110	254	
5E		00	00000000	0	
5F	Manufacture	41	01000001	65	A
60	Manufacture	55	01010101	85	U
61	Manufacture	4F	01001111	79	0
62		0A	00001010	10	
63		20	00100000	32	
64		20	00100000	32	
65		20	00100000	32	
66		20	00100000	32	
67		20	00100000	32	
68		20	00100000	32	
69		20	00100000	32	
6A		20	00100000	32	
6B		20	00100000	32	
6C	Detailed timing/monitor	00	00000000	0	
6D	descriptor #4	00	00000000	0	
6E		00	00000000	0	
6F		FE	11111110	254	
70		00	00000000	0	
71	Manufacture P/N	42	01000010	66	В
72	Manufacture P/N	31	00110001	49	1
73	Manufacture P/N	32	00110010	50	2
74	Manufacture P/N	31	00110001	49	1
75	Manufacture P/N	45	01000101	69	Е
76	Manufacture P/N	57	01010111	87	W
77	Manufacture P/N	31	00110001	49	1
78	Manufacture P/N	30	00110000	48	0
79	Manufacture P/N	20	00100000	32	
7 <b>A</b>	Manufacture P/N	56	01010110	86	V
7B	Manufacture P/N	32	00110010	50	2
7C		20	00100000	32	
7D		0A	00001010	10	
7E	Extension Flag	00	00000000	0	
7F	Checksum	B4	10110100	180	